

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad
○	1	47.24mil <1.200mm	NPTH	Round	Top Layer - Bottom Layer	Pad
⊠	1	62.99mil <1.600mm	NPTH	Round	Top Layer - Bottom Layer	Pad
⊠	4	90.55mil <2.300mm	NPTH	Round	Top Layer - Bottom Layer	Pad
⊕	44	15.00mil <0.381mm	PTH	Round	Top Layer - Bottom Layer	Pad
☆	639	8.00mil <0.203mm	PTH	Round	Top Layer - Bottom Layer	Via
▽	706	10.00mil <0.254mm	PTH	Round	Top Layer - Bottom Layer	Via
■	2009	6.00mil <0.152mm	PTH	Round	Top Layer - Bottom Layer	Via
	3404 Total					

FINISH : ENIG

MASK : GREEN

STACKUP AND MATERIAL : REFER THE ATTACHMENT<PDF>

VIA ON PAD TO BE CAPPED

